

# **CMOS Dual Up-Counters**

High-Voltage Types (20-Volt Rating)

CD4518B Dual BCD Up-Counter CD4520B Dual Binary Up-Counter

■ CD4518 Dual BCD Up-Counter and CD4520 Dual Binary Up-Counter each consist of two identical, internally synchronous 4-stage counters. The counter stages are D-type flip-flops having interchangeable CLOCK and ENABLE lines for incrementing on either the positive-going or negative-going transition. For single-unit operation the ENABLE input is maintained high and the counter advances on each positive-going transition of the CLOCK. The counters are cleared by high levels on their RESET lines.

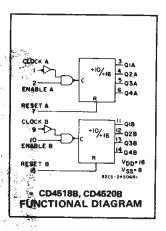
The counter can be cascaded in the ripple mode by connecting Q4 to the enable input of the subsequent counter while the CLOCK input of the latter is held low.

The CD4518B and CD4520B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

- Medium-speed operation -
  - 6-MHz typical clock frequency at 10 V
- Positive- or negative-edge triggering
- Synchronous internal carry propagation
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin(over full package-temperature range):  $1 \text{ V at V}_{DD} = 5 \text{ V}$

2 V at V<sub>DD</sub> = 10 V

- 2.5 V at V<sub>DD</sub> = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Standardized, symmetrical output
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



#### Applications:

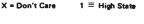
- Multistage synchronous counting
- Multistage ripple counting
- Frequency dividers

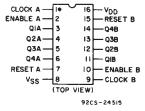
#### **TRUTH TABLE**

| CLOCK    | ENABLE | RESET | ACTION            |
|----------|--------|-------|-------------------|
| <b>\</b> | 1      | 0     | Increment Counter |
| 0        | ~      | 0     | Increment Counter |
| 7        | х      | 0     | No Change         |
| Х        | _      | 0     | No Change         |
|          | 0      | 0     | No Change         |
| 1        | 7      | 0     | No Change         |
| Х        | Х      | 1     | Q1 thru Q4 = 0    |

MAXIMUM RATINGS, Absolute-Maximum Values: DC SUPPLY-VOLTAGE RANGE, (VDD)

| 0.5V to +20V                              | Voltages referenced to V <sub>SS</sub> Terminal)        |
|---|---|
| 0.5V to V <sub>DD</sub> +0.5V             | INPUT VOLTAGE RANGE, ALL INPUTS                         |
| ±10mA                                     | DC INPUT CURRENT, ANY ONE INPUT                         |
|   | POWER DISSIPATION PER PACKAGE (PD):                     |
| 500mW                                     | For T <sub>A</sub> = -55°C to +100°C                    |
| inearity at 12mW/ <sup>o</sup> C to 200mW | For T <sub>A</sub> = +100°C to +125°C                   |
|   | DEVICE DISSIPATION PER OUTPUT TRANSISTOR                |
| 100mW                                     | FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package T) |
| 55°C to +125°C                            | OPERATING-TEMPERATURE RANGE (TA)                        |
| 65°C to +150°C                            | STORAGE TEMPERATURE RANGE (Tstq)                        |
|   | LEAD TEMPERATURE (DURING SOLDERING):                    |





0 ≡ Low State

#### CD4518B, CD4520R **TERMINAL ASSIGNMENT**

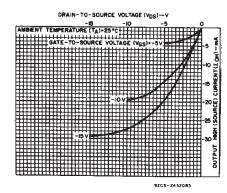


Fig. 3 - Typical output high (source) current

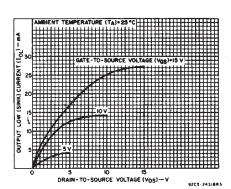


Fig. 1 - Typical output low (sink) current characteristics.

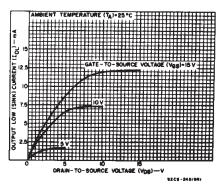


Fig. 2 - Minimum output low (sink) current characteristics.

#### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-<br>ISTIC                | CONDITIONS |      |            | LIMITS AT INDICATED TEMPERATURES (°C) |            |      |       |       |                   | UNITS |      |  |
|------------------------------------|------------|------|------------|---------------------------------------|------------|------|-------|-------|-------------------|-------|------|--|
|                                    | ٧o         | VIN  | VDD        |                                       |            |      | +25   |       |                   | UNI15 |      |  |
|                                    | (V)        | (V)  | (V)        | -55                                   | <b>-40</b> | +85  | +125  | Min.  | Тур.              | Max.  |      |  |
| Quiescent Device<br>Current,       |            | 0,5  | 5          | 5                                     | 5          | 150  | 150   | -     | 0.04              | 5     | μÀ   |  |
|                                    |            | 0,10 | 10         | 10                                    | 10         | 300  | 300   | -     | 0.04              | 10    |      |  |
| IDD Max.                           | -          | 0,15 | 15         | 20                                    | 20         | 600  | 600   | -     | 0.04              | 20    |      |  |
|                                    | -          | 0,20 | 20         | 100                                   | 100        | 3000 | 3000  | -     | 0.08              | 100   |      |  |
| Output Low                         | 0.4        | 0,5  | 5          | 0.64                                  | 0.61       | 0.42 | 0.36  | 0.51  | 1                 | -     |      |  |
| (Sink) Current                     | 0.5        | 0,10 | 10         | 1.6                                   | 1.5        | 1.1  | .0.9  | 1.3   | 2.6               | -     |      |  |
| IOL Min.                           | 1.5        | 0,15 | 15         | 4.2                                   | 4          | 2.8  | 2.4   | 34    | 6.8               | -     |      |  |
| Output High                        | 4.6        | 0,5  | 5          | -0.64                                 | 0.61       | 0.42 | -0.36 | -0.51 | -1                | -     | mA   |  |
| (Source)                           | 2.5        | 0,5  | 5          | -2                                    | -1.8       | -1.3 | -1.15 | -1.6  | -3.2              | -     |      |  |
| Current,<br>IOH Min.               | 9.5        | 0,10 | 10         | -1.6                                  | -1.5       | -1.1 | -0.9  | -1.3  | -2.6              | -     |      |  |
| 10H IIIII.                         | 13.5       | 0,15 | 15         | -4.2                                  | -4         | -2.8 | -2.4  | -3.4  | -6.8              |       |      |  |
| Output Voltage:                    | _          | 0,5  | 5          | 0.05                                  |            |      |       | 0     | 0.05              | V     |      |  |
| Low-Level,<br>VOL Max.             | -          | 0,10 | 10         | 0.05                                  |            |      |       | _     | 0                 |       | 0.05 |  |
| VOL max.                           | -          | 0,15 | 15         | 0.05                                  |            |      |       |       | 0                 |       | 0.05 |  |
| Output Voltage:                    | `-         | 0,5  | 5          | 4.95                                  |            |      | 4.95  | 5     | -                 |       |      |  |
| High-Level,                        |            | 0,10 | <b>∞10</b> | 9.95                                  |            |      |       | 9.95  | 10                |       | -    |  |
| VOH Min.                           | -          | 0,15 | 15         | 14.95                                 |            |      |       | 14.95 | 15                |       | -    |  |
| Input Low<br>Voltage,<br>VIL Max.  | 0.5, 4.5   | -    | 5          | 1.5                                   |            |      | _     | -     | 1.5               |       |      |  |
|                                    | 1, 9       | _    | 10         | 3                                     |            |      |       | _     |                   | 3     |      |  |
|                                    | 1.5,13.5   | _    | 15         | 4                                     |            |      | -     | _     | 4                 | V     |      |  |
| Input High<br>Voltage,<br>VIH Min. | 0.5, 4.5   |      | 5          | 3.5                                   |            |      | 3.5   | -     | _                 | v     |      |  |
|                                    | 1, 9       |      | 10         | 7                                     |            |      |       | 7     |                   |       |      |  |
|                                    | 1.5,13.5   | -    | 15         |                                       | 1          | 11   |       | 11    |                   | _     | L J  |  |
| Input Current<br>IJN Max.          | _          | 0,18 | 18         | ±0.1                                  | ±0.1       | ±1   | ±1    | 1     | ±10 <sup>-5</sup> | ±0.1  | μА   |  |

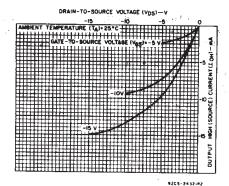


Fig. 4 — Minimum output high (source) current characteristics.

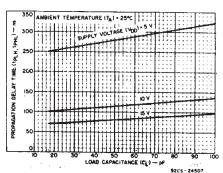


Fig. 5 — Typical propagation delay vs. load capacitance, clock or enable to output.

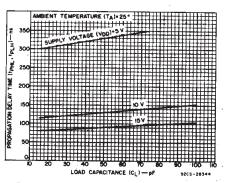


Fig. 6 — Typical propagation delay time vs. load capacitance, reset to output.

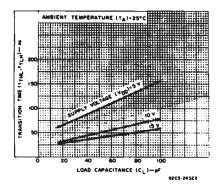


Fig. 7 — Typical transition time vs. load capacitance.

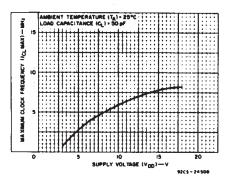


Fig. 8 — Typical maximum-clock-frequency vs. supply voltage.

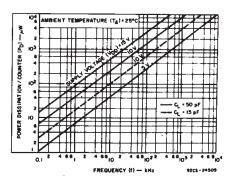


Fig. 9 — Typical power dissipation characteristics.

RECOMMENDED OPERATING CONDITIONS at  $T_A = 25^{\circ}$ C, Except as Noted. For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC   | V <sub>DD</sub> | LII  | UNITS        |     |  |
|--|-----------------|------|--------------|-----|--|
|  | (V)             | Min. | Max.         | 1   |  |
| Supply Voltage Range (For TA=Full Package-<br>Temperature Range) |                 | 3    | 18           | V   |  |
|  | 5               | 400  | · -          |     |  |
| Enable Pulse Width, t <sub>W</sub>                               | 10              | 200  | <b>-</b> .   | ns  |  |
|  | 15              | 140  |              |     |  |
|  | 5               | 200  | -            |     |  |
| Clock Pulse Width, tw  | 10              | 100  |              | ns  |  |
|  | 15              | 70   | . =          |     |  |
| ·  | 5               | •    | 1.5          |     |  |
| Clock Input Frequency, fCL                                       | 10              | dc   | 3            | MHz |  |
|  | 15              |      | 4            |     |  |
| Clock Rise or Fall Time, t <sub>r</sub> CL or t <sub>f</sub> CL: | 5<br>10<br>15   |      | 15<br>5<br>5 | μs  |  |
|  | 5               | 250  | -            |     |  |
| Reset Pulse Width, tw  | 10              | 110  |              | ns  |  |
|  | 15              | 80   |              |     |  |

# DYNAMIC ELECTRICAL CHARACTERISTICS at TA=25°C; Input tr,tr=20 ns, CL=50 pF, RL=200 K $\Omega$

| CHARACTERISTIC   | TEST CONDITIONS |                 | ı             | IMIT             | UNITS             |     |
|--|-----------------|-----------------|---------------|------------------|-------------------|-----|
|  |                 | V <sub>DD</sub> | Min.          | Тур.             | Max.              |     |
| Propagation Delay Time, tpHL, tpLH:<br>Clock or Enable to Output |                 | 5<br>10<br>15   | -             | 280<br>115<br>80 | 560<br>230<br>160 |     |
| Reset to Output  |                 | 5<br>10<br>15   |               | 330<br>130<br>90 | 650<br>225<br>170 | ns  |
| Transition Time, t <sub>THL</sub> , t <sub>TLH</sub>             |                 | 5<br>10<br>15   | 1 7 -         | 100<br>50<br>40  | 200<br>100<br>80  | ns  |
| Maximum Clock Input Frequency, fCL                               |                 | 5<br>10<br>15   | 1.5<br>3<br>4 | 3<br>6<br>8      |                   | MHz |
| Minimum Clock Pulse Width, tW                                    |                 | 5<br>10<br>15   |               | 100<br>50<br>35  | 200<br>100<br>70  | ns  |
| Clock Rise or Fall Time, t <sub>r</sub> or t <sub>f</sub> :      |                 | 5<br>10, 15     | _             | 1 1              | 15<br>5           | μς  |
| Minimum Reset Pulse Width, tw                                    |                 | 5<br>10<br>15   | -             | 125<br>55<br>40  | 250<br>110<br>80  | ns  |
| Minimum Enable Pulse Width, tw                                   | e e             | 5<br>10<br>15   | _             | 200<br>100<br>70 | 400<br>200<br>140 | ns  |
| Input Capacitance, C <sub>IN</sub>                               | Any Input       |                 |               | 5                | 7.5               | ρF  |

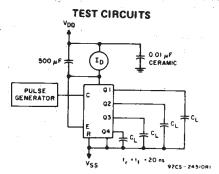


Fig. 10 - Dynamic power dissipation.

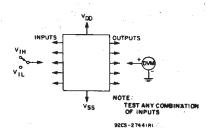


Fig. 11 - Input voltage.

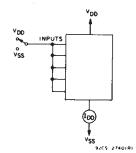


Fig. 12 — Quiescent device current test circuit.

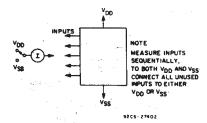
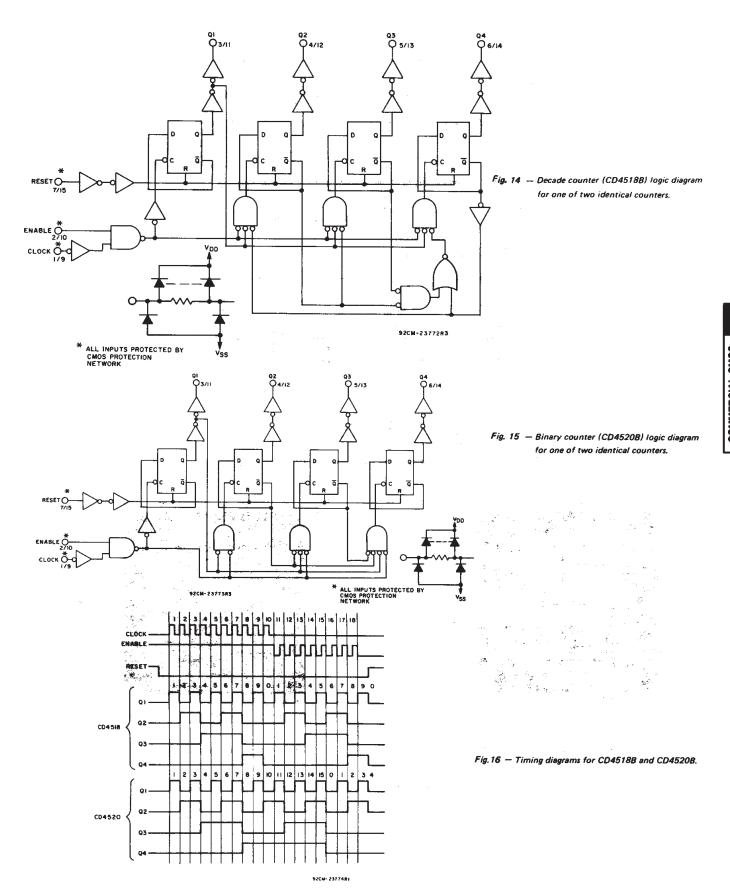


Fig. 13 — Input leakage-current test orcuit.



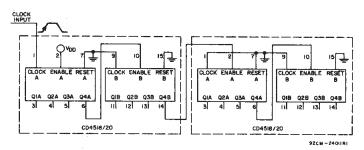
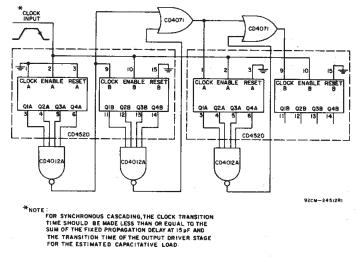
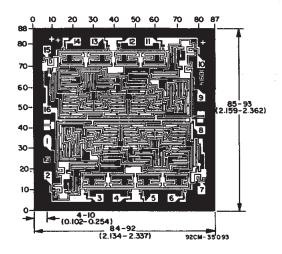


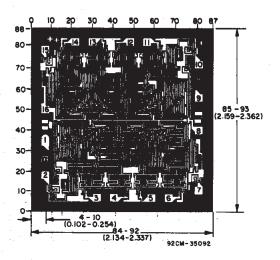
Fig. 17 - Ripple cascading of four counters with positive edge triggering.



 ${\it Fig. 18-Synchronous\ cascading\ of\ four\ binary\ counters\ with\ negative\ edge\ triggering.}$ 



Dimensions and pad layout for CD4518BH chip.



Dimensions and pad layout for CD45208H chip.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3} \, \text{inch})$ .

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